



# 6A, 100V - 200V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency switching
- DC/DC
- Snubber

#### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.088g (approximately)

| KEY PARAMETERS   |                |      |  |
|------------------|----------------|------|--|
| PARAMETER        | VALUE          | UNIT |  |
| I <sub>F</sub>   | 6              | Α    |  |
| $V_{RRM}$        | 100 - 200      | V    |  |
| I <sub>FSM</sub> | 160            | Α    |  |
| $T_{JMAX}$       | 175            | °C   |  |
| Package          | DO-214AA (SMB) |      |  |
| Configuration    | Single die     |      |  |









DO-214AA (SMB)



| PARAMETER                              | SYMBOL    | PU6BB               | PU6DB       | UNIT  |    |
|--|-----------|---------------------|-------------|-------|----|
| Marking code on the device             |           |                     | PU6BB       | PU6DB |    |
| Repetitive peak reverse voltage        |           | $V_{RRM}$           | 100         | 200   | V  |
| Reverse voltage, total rms value       |           | V <sub>R(RMS)</sub> | 70          | 140   | V  |
| Forward current                        |           | I <sub>F</sub>      | 6           |       | Α  |
| Surge peak forward current single half | t = 8.3ms |                     | 160<br>360  |       | A  |
| sine-wave superimposed on rated load   | t = 1.0ms | - I <sub>FSM</sub>  |             |       |    |
| Junction temperature                   |           | T <sub>J</sub>      | -55 to +175 |       | °C |
| Storage temperature                    |           | T <sub>STG</sub>    | -55 to +175 |       | °C |



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| THERMAL PERFORMANCE                    |                  |     |      |
|--|------------------|-----|------|
| PARAMETER                              | SYMBOL           | TYP | UNIT |
| Junction-to-lead thermal resistance    | R <sub>OJL</sub> | 12  | °C/W |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$  | 63  | °C/W |
| Junction-to-case thermal resistance    | R <sub>eJC</sub> | 16  | °C/W |

**Thermal Performance Note:** Units mounted on PCB (10mm x 10mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted) |  |                 |      |      |      |
|--|--|-----------------|------|------|------|
| PARAMETER  | CONDITIONS   | SYMBOL          | TYP  | MAX  | UNIT |
|  | I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C         |                 | 0.79 | -    | V    |
| Forward voltage <sup>(1)</sup>   | I <sub>F</sub> = 6A, T <sub>J</sub> = 25°C         | \/              | 0.85 | 0.94 | V    |
| Forward voitage  | I <sub>F</sub> = 3A, T <sub>J</sub> = 125°C        | V <sub>F</sub>  | 0.65 | -    | V    |
|  | I <sub>F</sub> = 6A, T <sub>J</sub> = 125°C        |                 | 0.71 | -    | V    |
| Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>                    | T <sub>J</sub> = 25°C                              |                 | -    | 2    | μA   |
|  | T <sub>J</sub> = 125°C                             | l <sub>R</sub>  | -    | 15   | μA   |
| Junction capacitance   | $1MHz$ , $V_R = 4.0V$                              | CJ              | 105  | -    | pF   |
| Dovorce recovery time  | $I_F = 0.5A$ , $I_R = 1.0A$ , $I_{rr} = 0.25A$     | 4               | -    | 25   | ns   |
| Reverse recovery time  | $I_F = 1.0A$ , di/dt = 50A/ $\mu$ s, $V_R = 30V$   | t <sub>rr</sub> | 31   | -    |      |
| Reverse recovery current   |  | I <sub>RM</sub> | 5.3  | -    | Α    |
| Reverse recovery charge  | $I_F = 6.0A$ , di/dt = 200A/ $\mu$ s, $V_R = 100V$ | Q <sub>rr</sub> | 72   | -    | nC   |
| Reverse recovery time  |  | t <sub>rr</sub> | 27   | -    | ns   |

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION         |                |                    |  |
|------------------------------|----------------|--------------------|--|
| ORDERING CODE <sup>(1)</sup> | PACKAGE        | PACKING            |  |
| PU6xB                        | DO-214AA (SMB) | 3,000/ Tape & Reel |  |

### Notes:

1. "x" defines voltage from 100V(PU6BB) to 200V(PU6DB)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

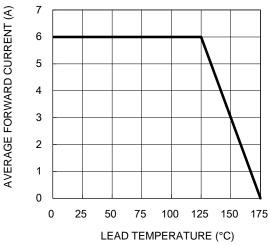


Fig.3 Typical Reverse Characteristics

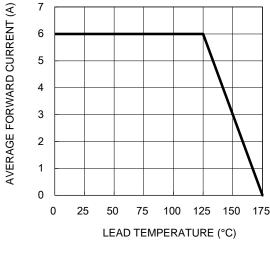


Fig.2 Typical Junction Capacitance

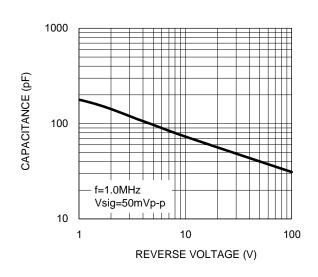
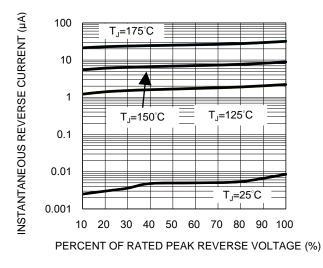


Fig.4 Typical Forward Characteristics



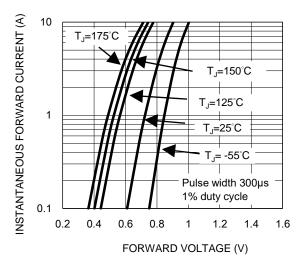
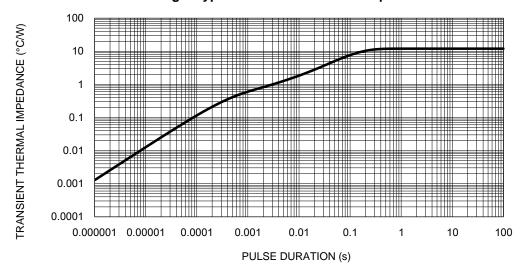


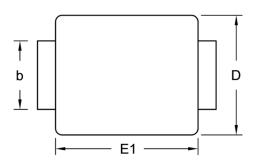
Fig.5 Typical Transient Thermal Impedance

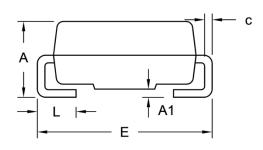




## **PACKAGE OUTLINE DIMENSIONS**

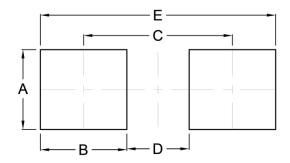
# DO-214AA (SMB)





| DIM. | Unit (mm) |      | Unit ( | (inch) |
|------|-----------|------|--------|--------|
| DIW. | Min.      | Max. | Min.   | Max.   |
| Α    | 1.95      | 2.65 | 0.077  | 0.104  |
| A1   | 0.05      | 0.20 | 0.002  | 0.008  |
| b    | 1.95      | 2.20 | 0.077  | 0.087  |
| С    | 0.15      | 0.31 | 0.006  | 0.012  |
| D    | 3.30      | 3.95 | 0.130  | 0.156  |
| E    | 5.10      | 5.60 | 0.201  | 0.220  |
| E1   | 4.05      | 4.60 | 0.159  | 0.181  |
| L    | 0.75      | 1.60 | 0.030  | 0.063  |

## **SUGGESTED PAD LAYOUT**



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α      | 2.30      | 0.091       |
| В      | 2.50      | 0.098       |
| С      | 4.30      | 0.169       |
| D      | 1.80      | 0.071       |
| E      | 6.80      | 0.268       |

## **MARKING DIAGRAM**



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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